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**Abstract:** The proceedings contain 221 papers. The topics discussed include: evaluation of reliability model in electrical system; research on wireless dynamic magnetic resonance charging technology for autonomous vehicles; key technologies for multi-pathing in high-reliability multi-controller storage systems; design of intelligent analog circuit generation system; design of upper computer detection system for vibration parameters of mechanical equipment; design of intelligent warehouse management system; speech emotion recognition based on graph convolutional neural networks; reinforcement learning based container placement strategies; a study on sentencing for traffic offences based on the decision tree algorithm; design and implementation of an ultrasonic audio jamming system; framework design and theoretical research on abstract account gas payment mechanism; and research on key technologies of control-by-wire system for trackless transportation robot in coal mines.

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